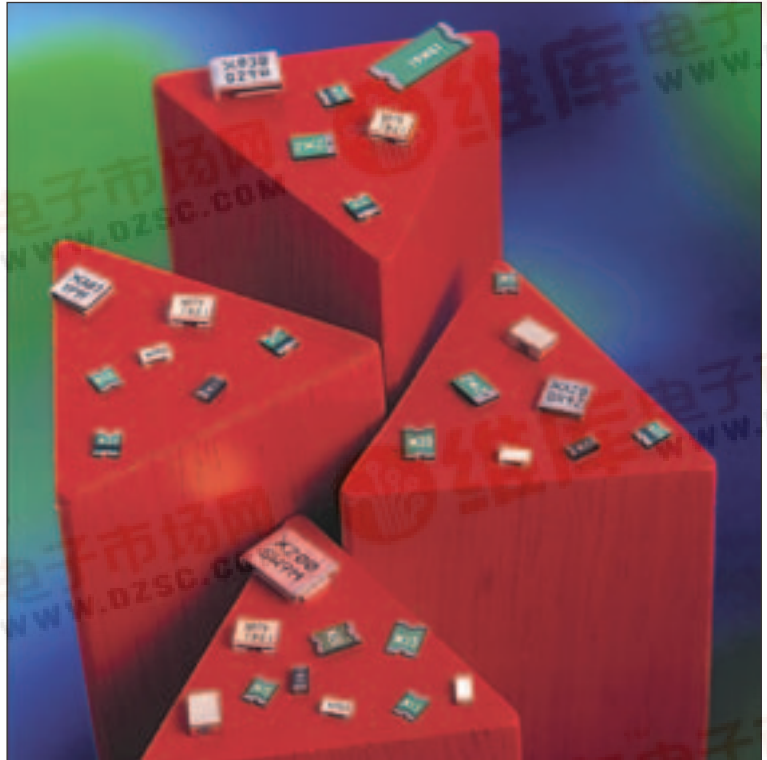


PolySwitch Surface-mount Resettable Devices

More than ten years ago, Raychem Circuit Protection introduced the SMD product family, and polymeric PTC devices quickly became the computer industry standard for keyboard, mouse, and disk drive protection. In 1995, Raychem Circuit Protection advanced the technology, reducing the size and cost of surface-mount resettable devices with the introduction of its miniSMD product series. The recent additions to the surface-mount family include the nanoSMD series, which reduces the size to a 3216mm (1206mils) foot print, one-third the size of the popular miniSMD series.



4

Benefits:

- Smaller size saves board space and cost
- Many product choices give engineers more design flexibility
- Compatible with high-volume electronics assembly
- Assists in meeting regulatory requirements
- Higher voltage ratings allow use in new applications

Features:

- Broadest range of resettable devices available in the industry
- Current ratings from 0.05 to 3A
- Voltage ratings from 6V computer and electronic applications to 60V (600V Telecom)
- Agency recognition: UL, CSA, TÜV
- Small footprint
- Fast time-to-trip
- Low resistance

Applications:

- Computer motherboards
- Modems
- USB hub, ports and peripherals
- IEEE1394 ports
- Digital cameras
- Disk drives
- CD-ROMs
- Game machines
- Battery packs
- Phones
- Fax machines
- Analog and digital line cards
- Printers
- PDAs
- Chargers



Selection Guide for Surface-mount Devices

Step 1. Determine the circuit's operating parameters.

Fill in the following information about the circuit:

Maximum ambient operating temperature _____

Normal operating current _____

Maximum operating voltage
(i.e. miniSMDC014 is 60V_{DC} max.) _____

Maximum interrupt current _____

Step 2. Select the PolySwitch device that will accommodate the circuit's maximum ambient temperature and normal operating current.

Look across the top of Table S2 to find the temperature that most closely matches the circuit's maximum operating temperature. Look down that column to find the value equal to or greater than the circuit's normal operating current. Now look to the far left of that row to find the part number for the PolySwitch surface-mount device that will best accommodate the circuit. Devices in this section are grouped by device dimensions, so your operating-current requirement may be found in more than one grouping.

The thermal derating curves located in Figure S1 are the normalized representations of the data in Table S2.

Step 3. Compare the selected device's maximum electrical ratings with the circuit's maximum operating voltage and interrupt current.

Look down the first column of Table S3 to find the part number you selected in Step 2. Look to the right in that row to find the device's maximum operating voltage (V_{MAX}) and maximum interrupt current (I_{MAX}). Ensure that V_{MAX} and I_{MAX} are greater than or equal to the circuit's maximum operating voltage and maximum interrupt current.



Step 4. Determine time-to-trip.

Time-to-trip is the amount of time it takes for a device to switch to a high-resistance state once a fault current has been applied across the device. Identifying the PolySwitch device's time-to-trip is important in order to provide the desired protection capabilities. If the device you choose trips too fast, undesired or nuisance tripping will occur. If the device trips too slowly, the components being protected may be damaged before the device switches to a high-resistance state.

Figures S11-S19 show the typical time-to-trip at 20°C for each of the PolySwitch devices.

If the PolySwitch device's time-to-trip is too fast or too slow for the circuit, go back to Step 2 and choose an alternate device.

Step 5. Verify ambient operating conditions.

Ensure that your application's minimum and maximum ambient temperatures are within the operating temperature of -40°C to 85°C (-40°C to 125°C for SMDH160).

Step 6. Verify the PolySwitch device dimensions.

Using dimensions in Table S4, compare the dimensions of the PolySwitch device you selected with the application's space considerations.



Protection Application Selection Table for Surface-mount Devices

The table below lists Polyswitch devices typically used in these applications.

Specifications for the suggested device part numbers can be found in this section.

Once a part has been selected, the user should evaluate and test each product for the intended application.

Protection Application	Additional Comments	Overcurrent Overvoltage	PolySwitch Resettable Devices—Key Selection Criteria		
			Small Size	Low Resistance	Fast Time-to-trip (Temperature Protection)
AC adapter input power	use w/ Zener & triac		SMD250	SMD250	SMD200
Battery pack protection			nanoSMDC150	miniSMDC260	miniSMDE190
Charger protection			nanoSMDM050	miniSMDM110/16	nanoSMDM075
CPU/IC protection			nanoSMDM100	nanoSMDC150	nanoSMDM075
Data acquisition/sensor			microSMD005	—	microSMD005
DC input/output power	≤6V		nanoSMDM075	nanoSMDC150	nanoSMDM050
	≤12V		miniSMDC075	miniSMDM110/16	miniSMDC075
DDC			nanoSMDM075	nanoSMDM100	nanoSMDM050
Device Bay system	DB12, DB20		miniSMDC200	miniSMDC260	miniSMDC200
	DB32		miniSMDC260	SMD300	miniSMDM200
Ethernet/Lan			nanoSMDM050	miniSMDM110/16	nanoSMDM075
Fan			microSMD035	microSMD050	microSMD035
IEEE 802.3af	VOIP		SMD050-2018	SMD050-2018	SMD050-2018
IEEE-1394	power provider		SMD100/33	SMD185	SMD100/33
	alt. power provider		SMD185	SMD185	SMD150/33
	self-powered		SMD185	SMD185	SMD150/33
LCD inverter			nanoSMDM050	miniSMDM110/16	nanoSMDM075
LCD screen power			nanoSMDM050	nanoSMDM050	microSMD035
LNB (Low Noise Block)			SMD075	SMD075	SMD050
Motor	≤6V		nanoSMDM100	nanoSMDC150	microSMDM075
	≤13.2V		miniSMDC075	miniSMDM110/16	miniSMDC075
PS/2 mouse/keyboard			nanoSMDM075	nanoSMDM100	nanoSMDM050
Signal - data communication	≤6V		nanoSMDM075	nanoSMDM075	nanoSMDM075
	≤13.2V		miniSMDC050	miniSMDM075	miniSMDC020
	≤30V		SMD030-2018	SMD075	SMD050
SCSI			nanoSMDM100	nanoSMDC150	nanoSMDM075
Smart card reader			microSMD010	microSMD035	microSMD005
Telecom - modem	UL1950	OC	TS600-170	TS250-130	TS600-170
		OV	TVB270SA or SC*	TVB270SA or SC*	TVB270SA or SC*
	ITU-T K.21	OC	TS250, TSV250	TS250, TSV250-130	TS250-130-RB
		OV	TVB270SA*	TVB270SA*	TVB270SA*
	Digital line	OC	miniSMDC014	miniSMDC014	miniSMDC014
		OV	TVB270SC*	TVB270SC*	TVB270SC*
Telecom - PBX	UL1950	OC	TS600-170	TS600-200-RA	TS600-170
		OV	TVB270SA or SC*	TVB270SA or SC*	TVB270SA or SC*
	ITU-T K.21	OC	TS250, TSV250	TS250-130	TS250-130-RB
		OV	TVB270SA*	TVB270SA*	TVB270SA*
	Subscriber	OC	miniSMDC014	miniSMDC014	miniSMDC014
		OV	miniSMDC014	miniSMDC014	miniSMDC014
Telecom - line card	Telcordia	OC	TS600-200-RA-B-0.5	TS600-200-RA-B-0.5	TS600-200-RA-B-0.5
		OV	TVB270SC*	TVB270SC*	TVB270SC*
	ITU-T K.20	OC	TS250, TSV250	TS250-130-RA	TS250
		OV	TVB270SA*	TVB270SA*	TVB270SA*
Intrabuilding protection	Telcordia GR1089		TSL250-080	SMD030-2018	TSL250-080
Temperature sensor	CPU		nanoSMDM050	nanoSMDM075	nanoSMDM050
USB	Individual Port		nanoSMDM075	nanoSMDM100	nanoSMDM050
	2 port ganged		nanoSMDC150	miniSMDC150	miniSMDC125
	3 port ganged		miniSMDC200	miniSMDM200	miniSMDM200

*Refer to the SIBerthaler product section for more information.



Table S1. Product Series: Size, Current Rating, Voltage Rating/Typical Resistance for Surface-mount Devices

	nanoSMDC nanoSMDM	microSMD	miniSMDC miniSMDM	midSMD	SMD	SMD2	miniSMDE	TS250 TSL250 TSV250	TS600
Size mm (mils)	3216 (1206)	3225 (1210)	4532 (1812)	5050 (2018)	7555 (2920)	8763 (3425)	11550 (4420)	*	*
Hold Current (A)	—	—	—	—	—	—	—	—	—
0.05	—	30V _{DC} /25Ω	—	—	—	—	—	—	—
0.08	—	—	—	—	—	—	—	80V/12.5Ω	—
0.100	30V _{DC} /12Ω	—	—	—	—	—	—	—	—
0.125	30V _{DC} /—	—	—	—	—	—	—	—	—
0.13	—	—	—	—	—	—	—	60V/6.0-8.0Ω	—
0.14	—	—	60V _{DC} /4.0Ω	—	—	—	—	—	—
0.160	30V _{DC} /—	—	—	—	—	—	—	—	—
0.17	—	—	—	—	—	—	—	—	60V/11.0Ω
0.18	—	—	—	—	—	—	—	—	—
0.20	24V _{DC} /—	—	30V _{DC} /1.4Ω	—	—	—	—	—	60V/8.5Ω
0.30	—	—	—	60V _{DC} /1.4Ω	60V _{DC} /3.0Ω	—	—	—	—
0.35	—	6V _{DC} /0.81Ω	—	—	—	—	—	—	—
0.50	6V _{DC} /0.40Ω	13.2V _{DC} /0.55Ω	24V _{DC} /0.60Ω	57V _{DC} /0.5Ω	60V _{DC} /0.87Ω	—	—	—	—
0.75	6V _{DC} /0.20Ω	6V _{DC} /0.29Ω	13.2V _{DC} /0.23Ω 24V _{DC} /0.20Ω	—	30V _{DC} /0.67Ω	—	—	—	—
1.00	6V _{DC} /0.15Ω	—	—	15V _{DC} /0.25Ω	30V _{DC} /0.30Ω 33V _{DC} /0.27Ω	—	—	—	—
1.10	6V _{DC} /—	6V _{DC} /0.14Ω	6V _{DC} /0.12Ω 8V _{DC} /0.14Ω 16V _{DC} /0.12Ω	—	—	—	—	—	—
1.25	—	—	6V _{DC} /0.09Ω	—	15V _{DC} /0.16Ω	—	—	—	—
1.50	6V _{DC} /0.08Ω	6V _{DC} /0.07Ω	6V _{DC} /0.07Ω	15V _{DC} /0.13Ω	—	15V _{DC} /0.16Ω 33V _{DC} /0.15Ω	—	—	—
1.60	—	—	8V _{DC} /0.066Ω	—	—	16V _{DC} /0.10Ω	—	—	—
1.85	—	—	—	—	—	33V _{DC} /0.12Ω	—	—	—
1.90	—	—	—	—	—	—	16V _{DC} /0.065Ω	—	—
2.00	—	—	6V _{DC} /0.050Ω 8V _{DC} /0.040Ω	6V _{DC} /0.07Ω	—	15V _{DC} /0.09Ω	—	—	—
2.50	—	—	—	—	—	15V _{DC} /0.06Ω	—	—	—
2.60	—	—	6V _{DC} /0.035Ω 6V _{DC} /0.030Ω	—	6V _{DC} /0.05Ω	—	—	—	—
3.00	—	—	—	—	6V _{DC} /0.033Ω	—	—	—	—

*Refer to Telecommunications and Networking section for dimensions; voltage for these parts is RMS max.



Table S2-A. Thermal Derating for Surface-mount Devices [Hold Current (A) at Ambient Temperature (°C)]

Part Number	Maximum Ambient Temperature											
	-40°C	-20°C	0°C	20°C	25°C	40°C	50°C	60°C	70°C	80°C	85°C	125°C
nanoSMDC Series Size 3216 mm/1206 mils												
nanoSMDC150	2.20	1.99	1.77	1.55	1.50	1.34	1.23	1.10	1.01	0.90	0.84	—
Lead-free devices are listed in Table S2-B												
nanoSMDM Series Size 3216 mm/1206 mils												
nanoSMDM012†	0.19	0.17	0.15	0.13	0.125	0.11	0.10	0.09	0.08	0.07	0.07	—
nanoSMDM016†	0.24	0.22	0.19	0.17	0.16	0.14	0.13	0.10	0.09	0.09	0.08	—
nanoSMDM050†	0.76	0.68	0.59	0.52	0.50	0.44	0.40	0.35	0.32	0.28	0.26	—
nanoSMDM075†	1.11	1.00	0.85	0.78	0.75	0.67	0.61	0.52	0.50	0.44	0.42	—
nanoSMDM100†	1.49	1.34	1.15	1.04	1.00	0.89	0.81	0.70	0.66	0.58	0.55	—
Lead-free devices are listed in Table S2-B												
microSMD Series Size 3225 mm/1210 mils												
microSMD005	0.08	0.07	0.06	0.05	0.05	0.04	0.04	0.03	0.03	0.02	0.02	—
microSMD010	0.15	0.13	0.12	0.10	0.10	0.09	0.08	0.07	0.06	0.05	0.05	—
microSMD035	0.51	0.46	0.40	0.35	0.34	0.30	0.27	0.24	0.22	0.19	0.18	—
microSMD050	0.76	0.66	0.58	0.50	0.48	0.42	0.38	0.35	0.29	0.25	0.23	—
microSMD075	1.10	0.97	0.86	0.75	0.72	0.64	0.58	0.55	0.47	0.42	0.39	—
microSMD110	1.60	1.42	1.26	1.10	1.06	0.94	0.86	0.80	0.70	0.62	0.58	—
microSMD150	2.30	2.02	1.76	1.50	1.43	1.24	1.11	1.00	0.85	0.72	0.65	—
Lead-free devices are listed in Table S2-B												
miniSMDC Series Size 4532 mm/1812 mils												
miniSMDC014	0.23	0.20	0.17	0.14	0.13	0.11	0.10	0.09	0.07	0.06	0.05	—
miniSMDC020	0.30	0.27	0.23	0.20	0.19	0.17	0.15	0.13	0.12	0.10	0.09	—
miniSMDC050	0.59	0.57	0.55	0.50	0.48	0.45	0.43	0.35	0.30	0.25	0.23	—
miniSMDC075	1.10	0.99	0.87	0.75	0.72	0.63	0.57	0.49	0.45	0.39	0.35	—
miniSMDC110	1.60	1.45	1.28	1.10	1.07	0.92	0.83	0.71	0.66	0.57	0.52	—
miniSMDC125	2.00	1.69	1.47	1.25	1.17	1.03	0.92	0.90	0.69	0.58	0.53	—
miniSMDC150	2.30	2.05	1.77	1.50	1.44	1.23	1.09	0.95	0.82	0.68	0.61	—
miniSMDC200	2.60	2.44	2.22	2.00	1.96	1.78	1.67	1.50	1.45	1.34	1.29	—
miniSMDC260	3.40	3.16	2.88	2.60	2.54	2.32	2.18	2.00	1.90	1.76	1.69	—
Lead-free devices are listed in Table S2-B												
miniSMDM Series Size 4532 mm/1812 mils												
miniSMDM075†	1.11	1.00	0.81	0.78	0.75	0.67	0.61	0.49	0.47	0.45	0.42	—
miniSMDM075/24†	1.11	1.00	0.85	0.78	0.75	0.67	0.61	0.52	0.50	0.44	0.42	—
miniSMDM110†	1.58	1.43	1.20	1.14	1.10	0.98	0.92	0.77	0.73	0.70	0.66	—
miniSMDM110/16†	1.61	1.46	1.25	1.14	1.10	0.98	0.90	0.78	0.74	0.66	0.62	—
miniSMDM150/24†	2.11	1.92	1.70	1.50	1.45	1.29	1.18	1.00	0.97	0.87	0.81	—
miniSMDM160†	2.32	2.10	1.80	1.66	1.60	1.43	1.32	1.14	1.10	0.99	0.93	—
miniSMDM200†	2.88	2.61	2.25	2.07	2.00	1.80	1.66	1.45	1.39	1.26	1.19	—
miniSMDM260†	3.70	3.36	2.90	2.68	2.60	2.35	2.18	1.90	1.84	1.67	1.59	—
Lead-free devices are listed in Table S2-B												
miniSMDE Series Size 11550 mm/4420 mils												
miniSMDE190	3.16	2.74	2.20	1.90	1.74	1.48	1.27	1.10	0.80	0.50	0.35	—
Lead-free devices are listed in Table S2-B												



Table S2-A. Thermal Derating for Surface-mount Devices [Hold Current (A) at Ambient Temperature (°C)]
continued

Part Number	Maximum Ambient Temperature											
	-40°C	-20°C	0°C	20°C	25°C	40°C	50°C	60°C	70°C	80°C	85°C	125°C
midSMD												
Size 5050 mm/2018 mils												
SMD030-2018	0.48	0.42	0.35	0.30	0.28	0.24	0.21	0.17	0.15	0.12	0.10	—
SMD050-2018	0.86	0.77	0.70	0.55	0.53	0.48	0.43	0.38	0.36	0.29	0.26	—
SMD100-2018	1.59	1.43	1.20	1.10	1.03	0.94	0.85	0.72	0.69	0.61	0.57	—
SMD150-2018	2.21	1.97	1.70	1.50	1.43	1.26	1.15	1.00	0.91	0.79	0.73	—
SMD200-2018	2.81	2.54	2.27	2.00	1.93	1.73	1.59	1.46	1.32	1.19	1.12	—

Lead-free devices are listed in Table S2-B

SMD												
Size 7555 mm/2920 mils												
SMD030	0.44	0.39	0.32	0.30	0.28	0.26	0.23	0.19	0.18	0.17	0.15	—
SMD050	0.73	0.65	0.55	0.50	0.47	0.43	0.39	0.33	0.31	0.28	0.26	—
SMD075	1.11	0.99	0.84	0.75	0.71	0.63	0.57	0.49	0.45	0.39	0.36	—
SMD100	1.59	1.43	1.20	1.10	1.03	0.94	0.85	0.72	0.69	0.61	0.57	—
SMD100/33	1.48	1.35	1.20	1.10	1.06	0.98	0.91	0.83	0.79	0.73	0.69	—
SMD125	1.89	1.68	1.50	1.25	1.21	1.04	0.93	0.85	0.71	0.61	0.55	—
SMD260	3.82	3.41	2.90	2.60	2.45	2.19	1.99	1.70	1.58	1.38	1.28	—
SMD260-RB	3.82	3.41	2.90	2.60	2.45	2.19	1.99	1.70	1.58	1.38	1.28	—
SMD300	4.13	3.75	3.30	3.00	2.87	2.62	2.43	2.25	2.00	1.87	1.78	—

Lead-free devices are listed in Table S2-B

SMD2												
Size 8763 mm/3425 mils												
SMD150	2.30	2.04	1.80	1.50	1.45	1.23	1.10	0.99	0.83	0.70	0.63	—
SMD150/33	2.30	2.04	1.80	1.50	1.45	1.23	1.10	0.99	0.83	0.70	0.63	—
SMDH160	2.15	1.96	1.78	1.60	1.55	1.42	1.33	1.24	1.15	1.05	1.01	0.64
SMD185	2.54	2.29	2.20	1.85	1.80	1.55	1.43	1.31	1.19	1.06	1.00	—
SMD200	3.01	2.67	2.30	2.00	1.90	1.66	1.50	1.30	1.16	0.99	0.91	—
SMD250	3.72	3.31	2.80	2.50	2.35	2.09	1.89	1.60	1.48	1.28	1.18	—

Lead-free devices are listed in Table S2-B

Telecom Surface-mount												
TSL250-080	0.124	0.110	0.095	0.080	0.077	0.066	0.059	0.051	0.044	0.037	0.033	—
TS250-130	0.208	0.182	0.156	0.130	0.124	0.104	0.091	0.078	0.065	0.052	0.045	—
TSV250-130	0.208	0.182	0.156	0.130	0.124	0.104	0.091	0.078	0.065	0.052	0.045	—
TS600-170	0.264	0.230	0.200	0.170	0.163	0.140	0.125	0.109	0.094	0.077	0.070	—
TS600-200-RA	0.310	0.275	0.238	0.200	0.193	0.165	0.147	0.128	0.110	0.091	0.083	—
TSM600-250	0.400	0.350	0.300	0.250	0.241	0.198	0.170	0.141	0.117	0.097	0.083	—

Table S2-B. Thermal Derating for Lead-free Surface-mount Devices
[Hold Current (A) at Ambient Temperature (°C)]

Part Number	Maximum Ambient Temperature											
	-40°C	-20°C	0°C	20°C	25°C	40°C	50°C	60°C	70°C	80°C	85°C	125°C
Lead-free nanoSMDC Series												
Size 3216 mm/1206 mils												
nanoSMDC020F	0.34	0.30	0.26	0.22	0.20	0.17	0.15	0.13	0.11	0.09	0.08	—
nanoSMDC035F	0.58	0.51	0.44	0.38	0.35	0.31	0.28	0.24	0.21	0.18	0.16	—
nanoSMDC050F/13.2	0.78	0.69	0.61	0.52	0.50	0.44	0.39	0.35	0.30	0.25	0.24	—
nanoSMDC075F	1.15	1.04	0.92	0.78	0.75	0.69	0.63	0.58	0.51	0.46	0.43	—

Table S2-B. Thermal Derating for Lead-free Surface-mount Devices [Hold Current (A) at Ambient Temperature (°C)]
continued

Part Number	Maximum Ambient Temperature											
	-40°C	-20°C	0°C	20°C	25°C	40°C	50°C	60°C	70°C	80°C	85°C	125°C
nanoSMDC110F	1.64	1.46	1.30	1.10	1.06	0.92	0.83	0.80	0.65	0.56	0.52	—
nanoSMDC150F	2.20	1.99	1.77	1.55	1.50	1.34	1.23	1.10	1.01	0.90	0.84	—
Lead-free nanoSMDM Series Size 3216 mm/1206 mils												
nanoSMDM012F	0.19	0.17	0.15	0.13	0.125	0.11	0.10	0.09	0.08	0.07	0.07	—
nanoSMDM020F	0.30	0.27	0.24	0.21	0.20	0.18	0.16	0.14	0.12	0.11	0.10	—
nanoSMDM050F	0.76	0.68	0.59	0.52	0.50	0.44	0.40	0.35	0.32	0.28	0.26	—
nanoSMDM050F/13.2	0.76	0.68	0.59	0.52	0.50	0.44	0.40	0.35	0.32	0.28	0.26	—
nanoSMDM075F	1.11	1.00	0.85	0.78	0.75	0.67	0.61	0.52	0.50	0.44	0.42	—
nanoSMDM100F	1.49	1.34	1.15	1.04	1.00	0.89	0.81	0.70	0.66	0.58	0.55	—
Lead-free microSMD Series Size 3225 mm/1210 mils												
microSMD005F	0.08	0.07	0.06	0.05	0.05	0.04	0.04	0.03	0.03	0.02	0.02	—
microSMD010F	0.15	0.13	0.12	0.10	0.10	0.09	0.08	0.07	0.06	0.05	0.05	—
microSMD035F	0.51	0.46	0.40	0.35	0.34	0.30	0.27	0.24	0.22	0.19	0.18	—
microSMD050F	0.76	0.66	0.58	0.50	0.48	0.42	0.38	0.35	0.29	0.25	0.23	—
microSMD075F	1.10	0.97	0.86	0.75	0.72	0.64	0.58	0.55	0.47	0.42	0.39	—
microSMD110F	1.60	1.42	1.26	1.11	1.06	0.94	0.86	0.80	0.70	0.62	0.58	—
microSMD150F	2.30	2.02	1.76	1.50	1.43	1.24	1.11	1.00	0.85	0.72	0.65	—
Lead-free miniSMDC Series Size 4532 mm/1812 mils												
miniSMDC014F	0.23	0.20	0.17	0.14	0.13	0.11	0.10	0.09	0.07	0.06	0.05	—
miniSMDC020F	0.30	0.27	0.23	0.20	0.19	0.17	0.15	0.13	0.12	0.10	0.09	—
miniSMDC050F	0.59	0.57	0.55	0.50	0.48	0.45	0.43	0.35	0.30	0.25	0.23	—
miniSMDC075F	1.10	0.99	0.87	0.75	0.72	0.63	0.57	0.49	0.45	0.39	0.35	—
miniSMDC110F	1.60	1.45	1.28	1.10	1.07	0.92	0.83	0.71	0.66	0.57	0.52	—
miniSMDC110F/16	1.68	1.49	1.30	1.10	1.05	0.92	0.83	0.75	0.64	0.55	0.50	—
miniSMDC125F	2.00	1.69	1.47	1.25	1.17	1.03	0.92	0.90	0.69	0.58	0.53	—
miniSMDC125F/16	2.00	1.69	1.47	1.25	1.17	1.03	0.92	0.90	0.69	0.58	0.53	—
miniSMDC150F	2.30	2.05	1.77	1.50	1.44	1.23	1.09	0.95	0.82	0.68	0.61	—
miniSMDC160F	2.50	2.19	1.89	1.60	1.53	1.31	1.16	1.10	0.95	0.79	0.71	—
miniSMDC200F	2.60	2.44	2.22	2.00	1.96	1.78	1.67	1.50	1.45	1.34	1.29	—
miniSMDC260F	3.40	3.16	2.90	2.60	2.54	2.32	2.18	2.00	1.90	1.76	1.69	—
miniSMDC260F/12	3.40	3.16	3.00	2.60	2.54	2.32	2.18	2.00	1.90	1.76	1.69	—
Lead-free miniSMDM Series Size 4532 mm/1812 mils												
miniSMDM075F/24	1.11	1.00	0.85	0.78	0.75	0.67	0.61	0.52	0.50	0.44	0.42	—
miniSMDM110F	1.58	1.43	1.20	1.14	1.10	0.98	0.92	0.77	0.73	0.70	0.66	—
miniSMDM110F/16	1.61	1.46	1.25	1.14	1.10	0.98	0.90	0.78	0.74	0.66	0.62	—
miniSMDM200F	2.88	2.61	2.25	2.07	2.00	1.80	1.66	1.45	1.39	1.26	1.19	—
miniSMDM260F	3.70	3.36	2.90	2.68	2.60	2.35	2.18	1.90	1.84	1.67	1.59	—
Lead-free SMD Series Size 5050 mm/2018 mils												
SMD030F-2018	0.18	0.42	0.35	0.30	0.28	0.24	0.21	0.17	0.15	0.12	0.10	—
SMD100F-2018	1.59	1.43	1.20	1.10	1.03	0.94	0.85	0.72	0.69	0.61	0.57	—
SMD150F-2018	2.21	1.97	1.70	1.50	1.43	1.26	1.15	1.00	0.91	0.79	0.73	—
SMD200F-2018	2.81	2.54	2.27	2.00	1.93	1.73	1.59	1.46	1.32	1.19	1.12	—



Table S2-B. Thermal Derating for Lead-free Surface-mount Devices [Hold Current (A) at Ambient Temperature (°C)]
continued

Part Number	Maximum Ambient Temperature											
	-40°C	-20°C	0°C	20°C	25°C	40°C	50°C	60°C	70°C	80°C	85°C	125°C
Lead-free SMD Series Size 5050 mm/2018 mils												
SMD030F-2018	0.48	0.42	0.35	0.30	0.28	0.24	0.21	0.17	0.15	0.12	0.10	—
SMD050F-2018	0.86	0.77	0.70	0.55	0.53	0.48	0.43	0.38	0.36	0.29	0.26	—
SMD100F-2018	1.59	1.43	1.20	1.10	1.03	0.94	0.85	0.72	0.69	0.61	0.57	—
SMD150F-2018	2.21	1.97	1.70	1.50	1.43	1.26	1.15	1.00	0.91	0.79	0.73	—
SMD200F-2018	2.81	2.54	2.27	2.00	1.93	1.73	1.59	1.46	1.32	1.19	1.12	—
Lead-free SMD Series Size 7555 mm/2920 mils												
SMD030F	0.44	0.39	0.32	0.30	0.28	0.26	0.23	0.19	0.18	0.17	0.15	—
SMD050F	0.73	0.65	0.55	0.50	0.47	0.43	0.39	0.33	0.31	0.28	0.26	—
SMD075F	1.11	0.99	0.84	0.75	0.71	0.63	0.57	0.49	0.45	0.39	0.36	—
SMD075F/60	1.11	0.99	0.84	0.75	0.71	0.63	0.57	0.49	0.45	0.39	0.36	—
SMD100F	1.59	1.43	1.20	1.10	1.03	0.94	0.85	0.72	0.69	0.61	0.57	—
SMD100F/33	1.48	1.35	1.20	1.10	1.06	0.98	0.91	0.83	0.79	0.73	0.69	—
SMD125F	1.89	1.68	1.50	1.25	1.21	1.04	0.93	0.85	0.71	0.61	0.55	—
SMD260F	3.82	3.41	2.90	2.60	2.45	2.19	1.99	1.70	1.58	1.38	1.28	—
SMD300F	4.13	3.75	3.30	3.00	2.87	2.62	2.43	2.25	2.00	1.87	1.78	—
Lead-free SMD2 Series Size 8763 mm/3425 mils												
SMD150F	2.30	2.04	1.80	1.50	1.45	1.23	1.10	0.99	0.83	0.70	0.63	—
SMD150F/33	2.30	2.04	1.80	1.50	1.45	1.23	1.10	0.99	0.83	0.70	0.63	—
SMD185F	2.54	2.29	2.20	1.85	1.80	1.55	1.43	1.31	1.19	1.06	1.00	—
SMD200F	3.01	2.67	2.30	2.00	1.90	1.66	1.50	1.30	1.16	0.99	0.91	—
SMD250F	3.72	3.31	2.80	2.50	2.35	2.09	1.89	1.60	1.48	1.28	1.18	—

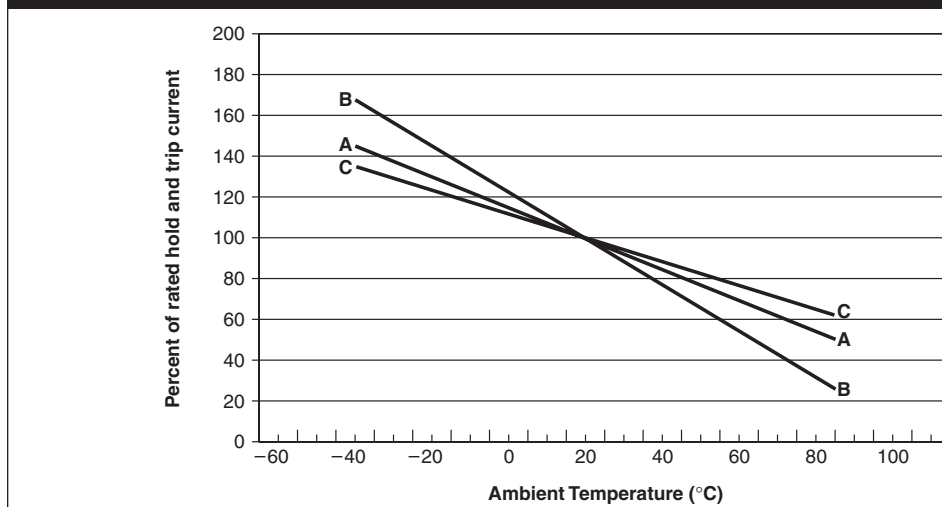
Thermal Derating Curves for Surface-mount Devices*

A = nanoSMD/microSMD/miniSMD & SMD

B = miniSMDE190

C = SMDH160

Figure S1. Thermal Derating Curve



*Refer to Telecom and Networking section for thermal derating of Telecom parts.



Table S3-A. Electrical Characteristics for Surface-mount Devices at 20°C

Part Number	I _H (A)	I _T (A)	V _{MAX} (V _{DC})	I _{MAX} (A)	P _{D TYP} (W)	Max. Time-to-Trip		R _{MIN} Ω	R _{TYP} Ω	R _{1 MAX} Ω	Figure for Dimensions
	(A)	(A)		(A)	(W)	(A)	(s)				
nanoSMDC Series Size 3216 mm / 1206 mils											
nanoSMDC150†	1.50	3.00	6	40	0.6	8.0	0.30	0.04	0.080	0.110	S3
Lead-free devices are listed in Table S3-B											
nanoSMDM Series Size 3216 mm / 1206 mils											
nanoSMDM012†	0.125	0.29	30	10	0.4	1.0	0.20	1.50	4.5	6.000	S2
nanoSMDM016†	0.16	0.37	30	10	0.4	1.0	0.30	1.20	3.5	4.500	S2
nanoSMDM050†	0.50	1.00	6	40	0.4	8.0	0.10	0.15	0.400	0.700	S2
nanoSMDM075†	0.75	1.50	6	40	0.4	8.0	0.20	0.10	0.200	0.290	S2
nanoSMDM100†	1.00	1.80	6	40	0.4	8.0	0.30	0.06	0.150	0.210	S2
Lead-free devices are listed in Table S3-B											
microSMD Series Size 3225 mm / 1210 mils											
microSMD005	0.05	0.15	30	10	0.6	0.25	1.5	3.60	25.00	50.000	S4
microSMD010	0.10	0.25	30	10	0.6	0.5	1.0	2.10	9.00	15.000	S3
microSMD035	0.35	0.75	6	40	0.6	8.0	0.2	0.32	0.81	1.300	S3
microSMD050	0.50	1.00	13.2	40	0.6	5.0	0.1	0.25	0.55	0.900	S3
microSMD075	0.75	1.50	6	40	0.6	8.0	0.1	0.11	0.29	0.400	S3
microSMD110	1.10	2.20	6	40	0.6	5.0	1.0	0.07	0.14	0.210	S3
microSMD150	1.50	3.00	6	40	0.6	5.0	5.0	0.04	0.07	0.110	S3
Lead-free devices are listed in Table S3-B											
miniSMDC Series Size 4532 mm / 1812 mils											
miniSMDC014	0.14	0.34	60	10	0.6	1.5	0.15	1.500	4.000	6.000	S3
miniSMDC020	0.20	0.40	30	10	0.6	8.0	0.02	0.600	2.900	3.300	S3
miniSMDC050	0.50	1.00	24	40	0.6	8.0	0.15	0.150	0.600	1.000	S3
miniSMDC075	0.75	1.50	13.2	40	0.6	8.0	0.20	0.110	0.260	0.450	S3
miniSMDC110	1.10	2.20	8	40	0.6	8.0	0.30	0.040	0.120	0.210	S3
miniSMDC125	1.25	2.50	6	40	0.6	8.0	0.40	0.050	0.090	0.140	S3
miniSMDC150	1.50	3.00	6	40	0.6	8.0	0.50	0.040	0.070	0.110	S3
miniSMDC200	2.00	4.00	6	40	0.6	8.0	5.00	0.020	0.050	0.070	S3
miniSMDC260	2.60	5.00	6	40	0.6	8.0	7.00	0.015	0.035	0.047	S3
Lead-free devices are listed in Table S3-B											
miniSMDM Series Size 4532 mm / 1812 mils											
miniSMDM075†	0.75	1.50	13.2	40	0.5	8.0	0.20	0.100	0.230	0.290	S2
miniSMDM075/24†	0.75	1.50	24	40	0.6	8.0	0.30	0.090	0.200	0.290	S5
miniSMDM110†	1.10	2.00	8	40	0.5	8.0	0.30	0.060	0.140	0.180	S2
miniSMDM110/16†	1.10	1.95	16	40	0.6	8.0	0.50	0.060	0.120	0.180	S5
miniSMDM150/24	1.50	3.00	24	20	0.6	8.0	1.50	0.040	—	0.120	S5
miniSMDM160†	1.60	2.80	8	40	0.6	8.0	2.00	0.033	0.066	0.099	S5
miniSMDM200†	2.00	3.50	8	40	0.6	8.0	3.00	0.020	0.040	0.060	S5
miniSMDM260†	2.60	4.55	6	40	0.6	8.0	6.00	0.010	0.030	0.043	S5
Lead-free devices are listed in Table S3-B											
miniSMDE Series Size 11550 mm / 4420 mils											
miniSMDE190	1.90	3.80	16	100	1.4	10	2.0	0.024	0.065	0.08	S3
Lead-free devices are listed in Table S3-B											

†Electrical characteristics determined at 25°C.



Table S3-A. Electrical Characteristics for Surface-mount Devices at 20°C *continued*

Part Number	I _H (A)	I _T (A)	V _{MAX} (V _{DC})	I _{MAX} (A)	P _{D TYP} (W)	Max. Time-to-Trip (A) (s)		R _{MIN} Ω	R _{TYP} Ω	R _{1 MAX} Ω	Figure for Dimensions
midSMD Size 5050 mm/2018 mils											
SMD030-2018	0.30	0.80	60	20	0.7	1.5	1.5	0.500	1.40	2.300	S6
SMD050-2018	0.55	1.20	57	10	1.0	2.5	5.0	0.200	—	1.000	S6
SMD100-2018	1.10	2.20	15	40	1.2	8.0	0.5	0.100	0.25	0.400	S6
SMD150-2018	1.50	3.00	15	40	1.4	8.0	1.0	0.070	0.13	0.180	S6
SMD200-2018	2.00	4.20	6	40	1.4	8.0	3.0	0.048	0.07	0.100	S6

SMD
Size 7555 mm/2920 mils

SMD030	0.30	0.60	60	10	1.5	1.5	3.0	1.200	3.00	4.800	S7
SMD050	0.50	1.00	60	10	1.5	2.5	4.0	0.350	0.87	1.400	S7
SMD075	0.75	1.50	30	40	1.5	8.0	0.3	0.350	0.67	1.000	S7
SMD100	1.10	2.20	30	40	1.5	8.0	0.5	0.120	0.30	0.480	S7
SMD100/33	1.10	2.20	33	40	1.5	8.0	0.5	0.120	0.27	0.410	S7
SMD125	1.25	2.50	15	40	1.5	8.0	2.0	0.070	0.16	0.250	S7
SMD260	2.60	5.20	6	40	1.5	8.0	20.0	0.025	0.05	0.075	S7
SMD260-RB	2.60	5.00	6	40	1.5	5.0	60.0	0.030	0.055	0.075	S7
SMD300	3.00	6.00	6	40	1.3	8.0	35.0	0.015	0.033	0.048	S7

Lead-free devices are listed in Table S3-B

SMD2
Size 8763 mm/3425 mils

SMD150	1.50	3.00	15	40	1.7	8.0	5.0	0.060	0.16	0.250	S7
SMD150/33	1.50	3.00	33	40	1.7	8.0	5.0	0.080	0.15	0.230	S7
SMDH160	1.60	3.20	16	70	2.1	8.0	15.0	0.050	0.10	0.150	S7
SMD185	1.80	3.60	33	40	1.2	8.0	5.0	0.065	0.12	0.165	S7
SMD200	2.00	4.00	15	40	1.7	8.0	12.0	0.050	0.09	0.125	S7
SMD250	2.50	5.00	15	40	1.7	8.0	25.0	0.035	0.06	0.085	S7

Lead-free devices are listed in Table S3-B

Part Number	I_H	I_T	V_{MAX}	I_{MAX}	$P_{D\ TYP}$	Max. Time-to-Trip		R_{MIN}	R_{TYP}	$R_{1\ MAX}$	Figure for Dimensions
	(A)	(A)	(V_{RMS})	(A)	(W)	(A)	(s)	Ω	Ω	Ω	
Telecom Surface-mount											
TSL250-080	0.080	0.16	250	3.0	1.2	1.0	0.8	5.0	11.0	20.0	S7
TS250-130	0.130	0.26	250	3.0	1.1	1.0	0.9	6.5	12.0	20.0	S8
	—	—	650	1.1	—	—	—	—	—	—	—
TSV250-130	0.130	0.26	250	3.0	1.5	1.0	2.0	4.0	7.0	12.0	S10
TS600-170	0.170	0.40	600	3.0	2.5	1.0	10.0	4.0	9.0	18.0	S9
TS600-200-RA	0.200	0.40	600	3.0	2.5	1.0	12.0	4.0	7.5	13.5	S9
TSM600-250	0.250	0.86	600	3.0	2.0	3.0	8.0	1.0	3.5	7.0	—



Table S3-B. Electrical Characteristics for Lead-free Surface-mount Devices at 20°C

Part Number	I _H (A)	I _T (A)	V _{MAX} (V _{DC})	I _{MAX} (A)	P _D TYP (W)	Max. Time-to-Trip (A) (s)		R _{MIN} Ω	R _{TYP} Ω	R ₁ MAX Ω	Figure for Dimensions
Lead-free nanoSMDC Series Size 3216 mm/1206 mils											
nanoSMDC020F†	0.20	0.42	24	100	0.6	8.0	0.10	0.65	—	2.600	S3
nanoSMDC035F†	0.35	0.75	16	20	0.6	3.5	0.10	0.45	—	1.400	S3
nanoSMDC050F/13.2†	0.50	1.10	13.2	40	0.6	8.0	0.10	0.20	—	0.800	S3
nanoSMDC075F†	0.75	1.50	6	40	0.6	8.0	0.10	0.12	—	0.400	S3
nanoSMDC110F	1.10	2.20	6	40	0.6	8.0	0.10	0.07	—	0.200	S3
nanoSMDC150F†	1.50	3.00	6	40	0.6	8.0	0.30	0.04	0.080	0.110	S3
Lead-free nanoSMDM Series Size 3216 mm/1206 mils											
nanoSMDM012F†	0.125	0.29	30	10	0.4	1.0	0.20	1.50	4.5	6.000	S2
nanoSMDM020F†	0.20	0.46	24	10	0.4	1.0	0.60	0.65	—	2.600	S2
nanoSMDM050F†	0.50	1.00	6	40	0.4	8.0	0.10	0.15	0.400	0.700	S2
nanoSMDM050F/13.2†	0.50	1.00	13.2	40	0.4	8.0	0.10	0.15	0.400	0.700	S2
nanoSMDM075F†	0.75	1.50	6	40	0.4	8.0	0.20	0.10	0.200	0.290	S2
nanoSMDM100F†	1.00	1.80	6	40	0.4	8.0	0.30	0.06	0.150	0.210	S2
Lead-free microSMD Series Size 3225 mm/1210 mils											
microSMD005F	0.05	0.15	30	10	0.6	0.25	1.5	3.60	25.00	50.000	S4
microSMD010F	0.10	0.25	30	10	0.6	0.5	1.0	2.10	9.00	15.000	S3
microSMD035F	0.35	0.75	6	40	0.6	8.0	0.2	0.33	0.81	1.300	S3
microSMD050F	0.50	1.00	13.2	40	0.6	5.0	0.1	0.25	0.55	0.900	S3
microSMD075F	0.75	1.50	6	40	0.6	8.0	0.1	0.11	0.29	0.400	S3
microSMD110F	1.10	2.20	6	40	0.6	5.0	1.0	0.07	0.14	0.210	S3
microSMD150F	1.50	3.00	6	40	0.6	5.0	5.0	0.04	0.07	0.110	S3
Lead-free miniSMDC Series Size 4532 mm/1812 mils											
miniSMDC014F	0.14	0.34	60	10	0.6	1.5	0.15	1.500	4.000	6.000	S3
miniSMDC020F	0.20	0.40	30	10	0.6	8.0	0.02	0.600	2.900	3.300	S3
miniSMDC050F	0.50	1.00	24	100	0.6	8.0	0.15	0.150	0.600	1.000	S3
miniSMDC075F	0.75	1.50	13.2	100	0.6	8.0	0.20	0.110	0.260	0.450	S3
miniSMDC110F	1.10	2.20	8	100	0.6	8.0	0.30	0.040	0.120	0.210	S3
miniSMDC110F/16	1.10	2.20	16	100	0.3	8.0	0.30	0.060	—	0.180	S3
miniSMDC125F	1.25	2.50	6	100	0.6	8.0	0.40	0.050	0.090	0.140	S3
miniSMDC125F/16	1.25	2.50	16	100	0.6	8.0	0.40	0.050	0.090	0.140	S3
miniSMDC150F	1.50	3.00	6	100	0.6	8.0	0.50	0.040	0.070	0.110	S3
miniSMDC160F	1.60	3.20	6	100	0.6	8.0	1.00	0.030	0.078	0.100	S3
miniSMDC200F	2.00	4.00	6	100	0.6	8.0	5.00	0.020	0.050	0.070	S3
miniSMDC260F	2.60	5.00	6	100	0.6	8.0	7.00	0.015	0.035	0.047	S3
miniSMDC260F/12	2.60	5.00	12	100	0.6	8.0	5.00	0.015	0.035	0.047	S3
Lead-free miniSMDM Series Size 4532 mm/1812 mils											
miniSMDM075F/24†	0.75	1.50	24	40	0.6	8.0	0.30	0.090	0.200	0.290	S5
miniSMDM110F†	1.10	2.00	8	40	0.5	8.0	0.30	0.060	0.140	0.180	S2
miniSMDM110F/16†	1.10	1.95	16	40	0.6	8.0	0.50	0.060	0.120	0.180	S2
miniSMDM200F†	2.00	3.50	8	40	0.6	8.0	3.00	0.020	0.040	0.060	S5
miniSMDM260F†	2.60	4.55	6	40	0.6	8.0	6.00	0.010	0.030	0.043	S5
Lead-free midSMD Series Size 5050 mm/2018 mils											
SMD030F-2018	0.30	0.80	60	20	0.9	1.5	1.50	0.500	1.400	2.300	S6
SMD100F-2018	1.10	2.20	15	40	1.2	8.0	0.50	0.100	0.250	0.400	S6



Table S3-B. Electrical Characteristics for **Lead-free** Surface-mount Devices at 20°C *continued*

Part Number	I_H (A)	I_T (A)	V_{MAX} (V _{DC})	I_{MAX} (A)	$P_{D\ TYP}$ (W)	Max. Time-to-Trip		R_{MIN} Ω	R_{TYP} Ω	$R_{1\ MAX}$ Ω	Figure for Dimensions
SMD150F-2018	1.50	3.00	15	40	1.4	8.0	1.00	0.070	0.130	0.180	S6
SMD200F-2018	2.00	4.20	6	40	1.4	8.0	3.00	0.048	0.700	0.100	S6

Lead-free SMD Series
Size 7555 mm/2920 mils

SMD030F	0.30	0.60	60	10	1.5	1.5	3.0	1.200	3.00	4.800	S7
SMD050F	0.50	1.00	60	10	1.5	2.5	4.0	0.350	0.87	1.400	S7
SMD075F	0.75	1.50	30	40	1.5	8.0	0.3	0.350	0.67	1.000	S7
SMD075F/60	0.75	1.50	60	10	1.5	8.0	0.3	0.350	0.67	1.000	S7
SMD100F	1.10	2.20	30	40	1.5	8.0	0.5	0.120	0.30	0.480	S7
SMD100F/33	1.10	2.20	33	40	1.5	8.0	0.5	0.120	0.27	0.410	S7
SMD125F	1.25	2.50	15	40	1.5	8.0	2.0	0.070	0.16	0.250	S7
SMD260F	2.60	5.20	6	40	1.5	8.0	20.0	0.025	0.05	0.075	S7
SMD300F	3.00	5.00	6	40	1.3	8.0	35.0	0.015	0.033	0.048	S7

Lead-free SMD2 Devices
Size 8763 mm/3425 mils

SMD150F	1.50	3.00	15	40	1.7	8.0	5.0	0.060	0.16	0.250	S7
SMD150F/33	1.50	3.00	33	40	1.7	8.0	5.0	0.080	0.15	0.230	S7
SMD185F	1.80	3.60	33	40	1.2	8.0	5.0	0.065	0.12	0.165	S7
SMD200F	2.00	4.00	15	40	1.7	8.0	12.0	0.050	0.09	0.125	S7
SMD250F	2.50	5.00	15	40	1.7	8.0	25.0	0.035	0.06	0.085	S7



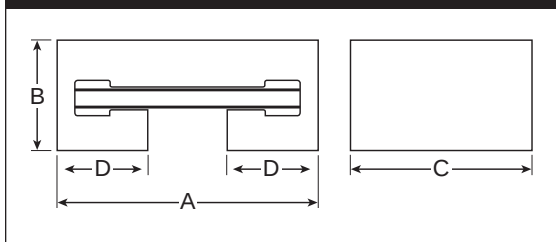
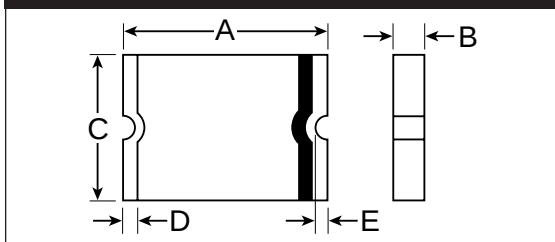
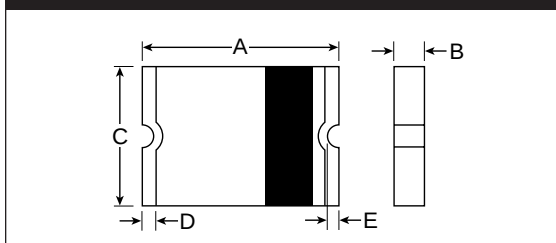
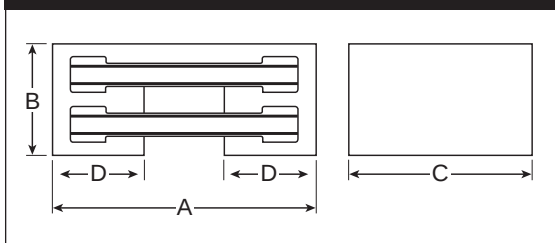
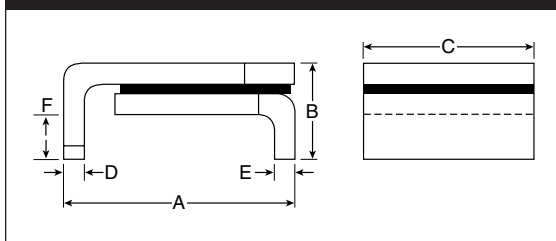
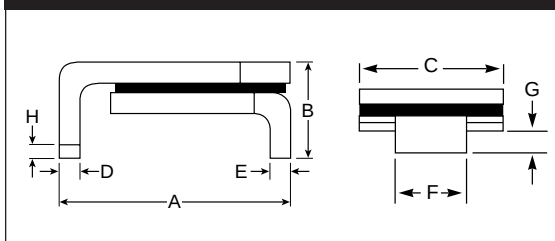
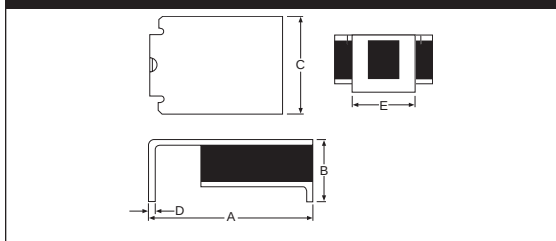
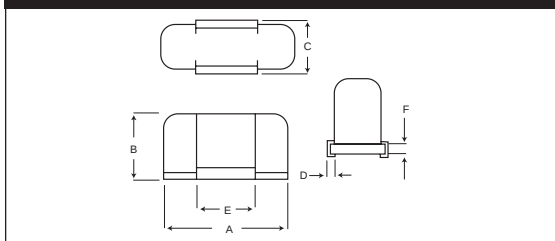
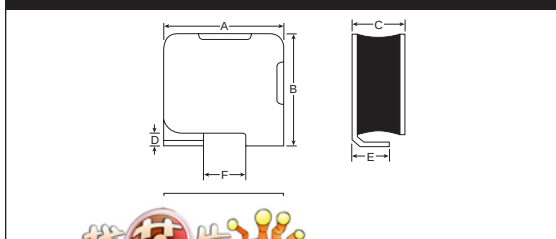
Figures S2–S10. Physical Description for Dimensions for Surface-mount Devices**Figure S2****Figure S3****Figure S4****Figure S5****Figure S6****Figure S7****Figure S8****Figure S9****Figure S10**

Table S4-A. Dimensions for Surface-mount Devices in Millimeters (Inches)

Part Number	Dimension															Figure
	A		B		C		D		E		F		G		H	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	
nanoSMD C Series Size 3216 mm/1206 mils																
nanoSMD C150	3.0 (0.118)	3.4 (0.134)	0.85 (0.033)	1.4 (0.055)	1.37 (0.054)	1.8 (0.071)	0.25 (0.010)	—	0.076 (0.003)	—	—	—	—	—	—	S3
Lead-free devices are listed in Table S4-B																
nanoSMD M Series Size 3216 mm/1206 mils																
nanoSMD M012	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMD M016	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMD M050	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMD M075	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMD M100	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
Lead-free devices are listed in Table S4-B																
microSMD Series Size 3225 mm/1210 mils																
microSMD 005	3.00 (0.118)	3.43 (0.135)	0.50 (0.019)	0.85 (0.034)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S4
microSMD 010	3.00 (0.118)	3.43 (0.135)	0.50 (0.019)	0.85 (0.034)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
microSMD 035	3.00 (0.118)	3.43 (0.135)	0.38 (0.015)	0.62 (0.025)	2.35 (0.092)	2.80 (0.110)	0.30 (0.012)	—	0.25 (0.010)	—	—	—	—	—	—	S3
microSMD 050	3.00 (0.118)	3.43 (0.135)	0.38 (0.015)	0.62 (0.025)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
microSMD 075	3.00 (0.118)	3.43 (0.135)	0.38 (0.015)	0.62 (0.025)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
microSMD 110	3.00 (0.118)	3.43 (0.135)	0.28 (0.011)	0.48 (0.019)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
microSMD 150	3.00 (0.118)	3.43 (0.135)	0.51 (0.020)	1.22 (0.048)	2.35 (0.092)	2.80 (0.110)	0.30 (0.012)	—	0.25 (0.010)	—	—	—	—	—	—	S3
Lead-free devices are listed in Table S4-B																
miniSMD C Series Size 4532 mm/1812 mils																
miniSMD C014	4.37 (0.172)	4.73 (0.186)	0.635 (0.025)	0.89 (0.035)	3.07 (0.121)	3.41 (0.134)	0.30 (0.012)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C020	4.37 (0.172)	4.73 (0.186)	0.635 (0.025)	0.89 (0.035)	3.07 (0.121)	3.41 (0.134)	0.30 (0.012)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C050	4.37 (0.172)	4.73 (0.186)	0.38 (0.015)	0.62 (0.025)	3.07 (0.121)	3.41 (0.134)	0.30 (0.012)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C075	4.37 (0.172)	4.73 (0.186)	0.38 (0.015)	0.62 (0.025)	3.07 (0.121)	3.41 (0.134)	0.30 (0.012)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C110	4.37 (0.172)	4.73 (0.186)	0.38 (0.015)	0.62 (0.025)	3.07 (0.121)	3.41 (0.134)	0.30 (0.012)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C125	4.37 (0.172)	4.73 (0.186)	0.28 (0.011)	0.48 (0.019)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C150	4.37 (0.172)	4.73 (0.186)	0.28 (0.011)	0.48 (0.019)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C200	4.37 (0.172)	4.73 (0.186)	0.51 (0.020)	1.22 (0.048)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
miniSMD C260	4.37 (0.172)	4.73 (0.186)	0.76 (0.030)	1.25 (0.050)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
Lead-free devices are listed in Table S4-B																
miniSMD M Series Size 4532 mm/1812 mils																
miniSMD M075	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S2
miniSMD M075/24	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S5



Table S4. Dimensions for Surface-mount Devices in Millimeters (Inches) *continued*

Part Number	Dimension															Figure
	A		B		C		D		E		F		G		H	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.		
miniSMDM Series Size 4532 mm/1812 mils <i>continued</i>																
miniSMDM110	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S2
miniSMDM110/16	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S5
miniSMDM150/24	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S5
miniSMDM160	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S5
miniSMDM200	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S5
miniSMDM260	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	—	S5

Lead-free devices are listed in Table S4-B

miniSMD E Series
Size 11550 mm/4420 mils

miniSMD E190	11.15 (0.439)	11.51 (0.453)	0.33 (0.013)	0.53 (0.021)	4.83 (0.190)	5.33 (0.210)	0.51 (0.020)	1.02 (0.040)	3.81 (0.015)	—	—	—	—	—	—	S3
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midSMD
Size 5050 mm/2018 mils

SMD030-2018	4.72 (0.186)	5.44 (0.214)	—	1.78 (0.070)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
SMD050-2018	4.72 (0.186)	5.44 (0.214)	—	1.78 (0.070)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
SMD100-2018	4.72 (0.186)	5.44 (0.214)	—	1.52 (0.060)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
SMD150-2018	4.72 (0.186)	5.44 (0.214)	—	1.52 (0.060)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
SMD200-2018	4.72 (0.186)	5.44 (0.214)	—	1.52 (0.060)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6

SMD
Size 7555 mm/2920 mils

SMD030	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD050	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.20 (0.008)	0.30 (0.012)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD075	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD100	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD100/33	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD125	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD260	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD260-RB	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD300	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.8 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7

Lead-free devices are listed in Table S4-B

SMD2
Size 8763 mm/3425 mils

SMD150	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD150/33	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMDH160	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD185	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7



Table S4-A. Dimensions for Surface-mount Devices in Millimeters (Inches) *continued*

Dimension																
Part Number	A		B		C		D		E		F		G		H	Figure
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min	Max.	Min.	
SMD2																
Size 8763 mm/3425 mils <i>continued</i>																
SMD200	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD250	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.0 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
Lead-free devices are listed in Table S4-B																
Telecom Surface-mount																
TSL250-080	6.7 (0.265)	7.9 (0.310)	2.7 (0.110)	3.7 (0.145)	4.8 (0.190)	5.3 (0.210)	0.2 (0.008)	0.4 (0.015)	2.5 (0.100)	3.1 (0.120)	—	—	—	—	—	S7
TS250-130	8.5 (0.335)	9.4 (0.370)	—	3.4 (0.135)	—	7.4 (0.290)	0.3 (0.011)	—	3.8 (0.150)	—	—	—	—	—	—	S8
TSV250-130	—	6.1 (0.240)	—	6.9 (0.270)	—	3.2 (0.126)	0.56 (0.022)	—	—	1.9 (0.075)	1.6 (0.065)	2.31 (0.091)	—	—	—	S10
TS600-170	18.2 (0.720)	19.4 (0.765)	11.5 (0.455)	12.3 (0.485)	7.2 (0.285)	8.3 (0.325)	1.6 (0.065)	2.4 (0.095)	9.9 (0.390)	10.4 (0.410)	1.5 (0.060)	2.3 (0.090)	—	—	—	S9
TS600-200-RA	18.2 (0.720)	19.4 (0.765)	11.5 (0.455)	12.3 (0.485)	7.2 (0.285)	8.3 (0.325)	1.6 (0.065)	2.4 (0.095)	9.9 (0.390)	10.4 (0.410)	1.5 (0.060)	2.3 (0.090)	—	—	—	S9
TSM600-250	—	17.6 (0.69)	—	11.7 (0.46)	—	11.2 (0.44)	5.2 (0.20)	—	5.2 (0.21)	2.8 (0.02)	0.6 (0.02)	—	—	—	—	—
TSM600-250-RA	—	17.6 (0.69)	—	11.7 (0.46)	—	11.2 (0.44)	5.2 (0.20)	—	5.2 (0.11)	2.8 (0.11)	0.6 (0.02)	—	—	—	—	—

Table S4-B. Dimensions for Lead-free Surface-mount Devices in Millimeters (Inches)

Part Number	Dimension															Figure
	A		B		C		D		E		F		G		H	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	
Lead-free nanoSMDC Series																
Size 3216 mm/1206 mils																
nanoSMDC020F	3.0 (0.118)	3.4 (0.134)	0.38 (0.015)	0.64 (0.025)	1.37 (0.054)	1.80 (0.071)	0.15 (0.006)	—	0.076 (0.003)	—	—	—	—	—	—	S3
nanoSMDC035F	3.0 (0.118)	3.4 (0.134)	0.38 (0.015)	0.64 (0.025)	1.37 (0.054)	1.80 (0.071)	0.15 (0.006)	—	0.076 (0.003)	—	—	—	—	—	—	S3
nanoSMDC050F/13.2	3.0 (0.118)	3.4 (0.134)	0.38 (0.015)	0.64 (0.025)	1.37 (0.054)	1.80 (0.071)	0.15 (0.006)	—	0.076 (0.003)	—	—	—	—	—	—	S3
nanoSMDC075F	3.0 (0.118)	3.4 (0.134)	0.25 (0.010)	0.38 (0.015)	1.37 (0.054)	1.80 (0.071)	0.15 (0.006)	—	0.076 (0.003)	—	—	—	—	—	—	S3
nanoSMDC110F	3.0 (0.118)	3.4 (0.134)	0.67 (0.026)	1.00 (0.039)	1.37 (0.054)	1.80 (0.071)	0.25 (0.010)	—	0.076 (0.003)	—	—	—	—	—	—	S3
nanoSMDC150F	3.0 (0.118)	3.4 (0.134)	0.85 (0.033)	1.40 (0.055)	1.37 (0.054)	1.80 (0.071)	0.25 (0.010)	—	0.076 (0.003)	—	—	—	—	—	—	S3
Lead-free nanoSMDM Series																
Size 3216 mm/1206 mils																
nanoSMDM012F	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMDM020F	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMDM050F	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMDM050F/13.2	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMDM075F	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
nanoSMDM100F	3.0 (0.118)	3.4 (0.134)	0.8 (0.032)	1.2 (0.047)	1.4 (0.055)	1.8 (0.071)	0.75 (0.030)	1.05 (0.041)	—	—	—	—	—	—	—	S2
Lead-free microSMD Series																
Size 3225 mm/1210 mils																
microSMD005F	3.00 (0.118)	3.43 (0.135)	0.50 (0.019)	0.85 (0.034)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3
microSMD010F	3.00 (0.118)	3.43 (0.135)	0.50 (0.019)	0.85 (0.034)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	—	S3

Table S4-B. Dimensions for Lead-free Surface-mount Devices in Millimeters (Inches) *continued*

Part Number	Dimension															Figure
	A		B		C		D		E		F		G		H	
	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	
microSMD035F	3.00 (0.118)	3.43 (0.135)	0.38 (0.015)	0.62 (0.025)	2.35 (0.092)	2.80 (0.110)	0.30 (0.012)	—	0.25 (0.010)	—	—	—	—	—	S3	
microSMD050F	3.00 (0.118)	3.43 (0.135)	0.38 (0.015)	0.62 (0.025)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
microSMD075F	3.00 (0.118)	3.43 (0.135)	0.38 (0.015)	0.62 (0.025)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
microSMD110F	3.00 (0.118)	3.43 (0.135)	0.28 (0.011)	0.48 (0.019)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
microSMD150F	3.00 (0.118)	3.43 (0.135)	0.51 (0.020)	1.22 (0.048)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
Lead-free microSMD Series Size 3225 mm/1210 mils <i>continued</i>																
microSMD110F	3.00 (0.118)	3.43 (0.135)	0.28 (0.011)	0.48 (0.019)	2.35 (0.092)	2.80 (0.110)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
microSMD150F	3.00 (0.118)	3.43 (0.135)	0.51 (0.020)	1.22 (0.048)	2.35 (0.092)	2.80 (0.110)	0.30 (0.012)	—	0.25 (0.010)	—	—	—	—	—	S3	
Lead-free miniSMDC Series Size 4532 mm/1812 mils																
miniSMDC014F	4.37 (0.172)	4.73 (0.186)	0.635 (0.025)	0.89 (0.035)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC020F	4.37 (0.172)	4.73 (0.186)	0.635 (0.025)	0.89 (0.035)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC050F	4.37 (0.172)	4.73 (0.186)	0.38 (0.015)	0.62 (0.025)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC075F	4.37 (0.172)	4.73 (0.186)	0.38 (0.015)	0.62 (0.025)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC110F	4.37 (0.172)	4.73 (0.186)	0.38 (0.015)	0.62 (0.025)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC110F/16	4.37 (0.172)	4.73 (0.186)	0.38 (0.015)	0.62 (0.025)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC125F	4.37 (0.172)	4.73 (0.186)	0.28 (0.011)	0.48 (0.019)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC125F/16	4.37 (0.172)	4.73 (0.186)	0.28 (0.011)	0.48 (0.019)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC150F	4.37 (0.172)	4.73 (0.186)	0.28 (0.011)	0.48 (0.019)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC160F	4.37 (0.172)	4.73 (0.186)	0.28 (0.011)	0.48 (0.019)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC200F	4.37 (0.172)	4.73 (0.186)	0.51 (0.020)	1.22 (0.048)	3.07 (0.121)	3.41 (0.134)	0.25 (0.010)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC260F	4.37 (0.172)	4.73 (0.186)	0.76 (0.030)	1.25 (0.050)	3.07 (0.121)	3.41 (0.134)	0.25 (0.012)	—	0.20 (0.008)	—	—	—	—	—	S3	
miniSMDC260F/12	4.37 (0.172)	4.73 (0.186)	0.76 (0.030)	1.25 (0.050)	3.07 (0.121)	3.41 (0.134)	0.25 (0.012)	—	0.20 (0.008)	—	—	—	—	—	S3	
Lead-free miniSMDM Series Size 4532 mm/1812 mils																
miniSMDM075F/24	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	S5	
miniSMDM110F	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	S2	
miniSMDM110F/16	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	S5	
miniSMDM200F	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	S5	
miniSMDM260F	4.35 (0.172)	4.75 (0.187)	1.75 (0.069)	2.00 (0.079)	3.05 (0.120)	3.60 (0.142)	1.4 (0.055)	1.7 (0.067)	—	—	—	—	—	—	S5	



Table S4-B. Dimensions for **Lead-free** Surface-mount Devices in Millimeters (Inches) *continued*

Dimension																
	A		B		C		D		E		F		G		H	
Part Number	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Figure
Lead-free midSMD Series Size 5050 mm/2018 mils																
SMD030F-2018	4.72 (0.186)	5.44 (0.214)	—	1.78 (0.070)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
SMD100F-2018	4.72 (0.186)	5.44 (0.214)	—	1.52 (0.060)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
SMD150F-2018	4.72 (0.186)	5.44 (0.214)	—	1.52 (0.060)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
SMD200F-2018	4.72 (0.186)	5.44 (0.214)	—	1.52 (0.060)	4.22 (0.166)	4.93 (0.194)	0.25 (0.010)	0.36 (0.014)	0.25 (0.010)	0.36 (0.014)	0.30 (0.012)	0.46 (0.018)	—	—	—	S6
Lead-free SMD Series Size 7555 mm/2920 mils																
SMD030F	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD050F	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.80 (0.19)	5.44 (0.214)	0.20 (0.008)	0.30 (0.012)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD075F	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD075F/60	6.73 (0.265)	7.98 (0.314)	—	3.18 (0.125)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD100F	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD100F/33	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD125F	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD260F	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD300F	6.73 (0.265)	7.98 (0.314)	—	3.00 (0.118)	4.80 (0.19)	5.44 (0.214)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	2.16 (0.085)	2.41 (0.095)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
Lead-free SMD2 Series Size 8763 mm/3425 mils																
SMD150F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.00 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD150F/33	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.00 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD185F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.00 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD200F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.00 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7
SMD250F	8.00 (0.315)	9.40 (0.370)	—	3.00 (0.118)	6.00 (0.236)	6.71 (0.264)	0.56 (0.022)	0.71 (0.028)	0.56 (0.022)	0.71 (0.028)	3.68 (0.145)	3.94 (0.155)	0.66 (0.026)	1.37 (0.054)	0.43 (0.017)	S7

Figures S11–S19. Typical Time-to-trip Curves at 20°C for Surface-mount Devices

Telecom and Networking Devices

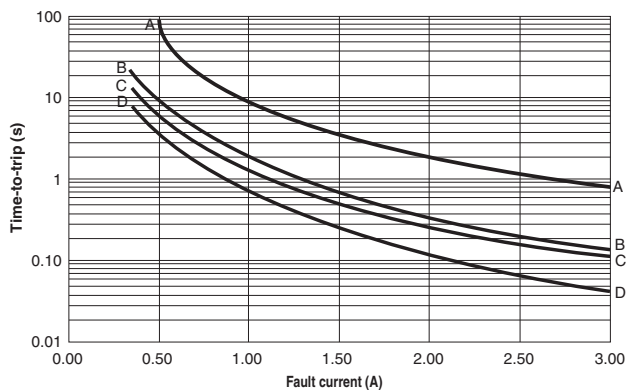
A = TS600-170/TS600-200

B = TS250-130

C = TSV250-130

D = TSL250-080

Figure S11



nanoSMDC and nanoSMDCxxxF

A = nanoSMDC020F

B = nanoSMDC035F

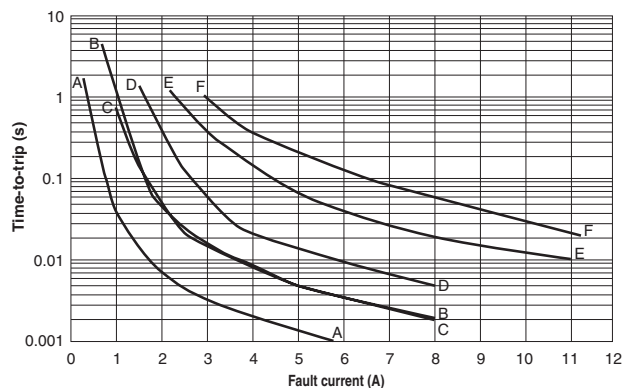
C = nanoSMDC050F/13.2

D = nanoSMDC075F

E = nanoSMDC110F

F = nanoSMDC150,
nanoSMDC150F

Figure S12



nanoSMDM and nanoSMDMxxxF

A = nanoSMDM012,
nanoSMDM012F

B = nanoSMDM016

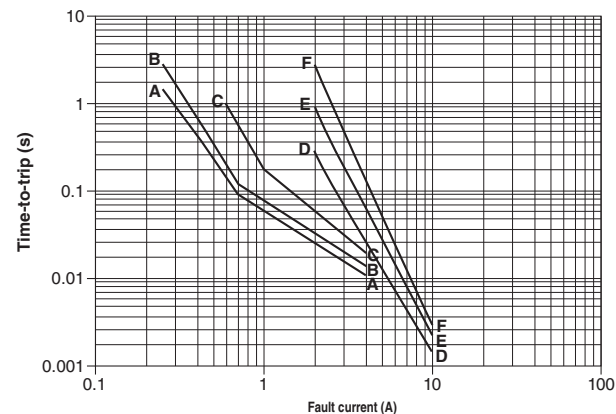
C = nanoSMDM020F

D = nanoSMDM050,
nanoSMDM050F,
nanoSMDM050F/13.2

E = nanoSMDM075,
nanoSMDM075F

F = nanoSMDM100,
nanoSMDM100F

Figure S13

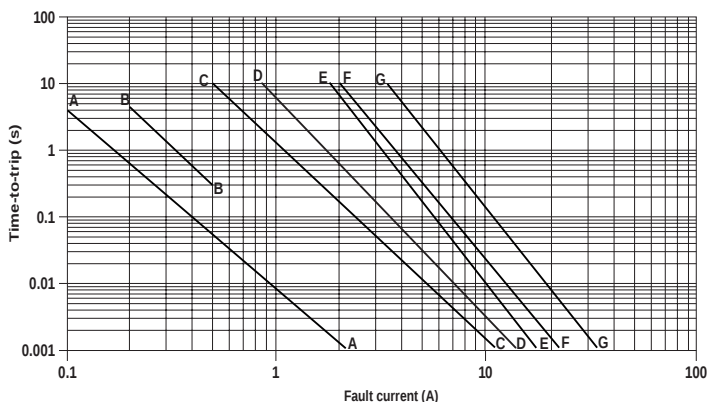


Figures S11–S19. Typical Time-to-trip Curves at 20°C for Surface-mount Devices *continued*

microSMD and microSMDF

- A = microSMD005,
microSMD005F
B = microSMD010,
microSMD010F
C = microSMD035,
microSMD035F
D = microSMD050,
microSMD050F
E = microSMD075,
microSMD075F
F = microSMD110,
microSMD110F
G = microSMD150,
microSMD150F

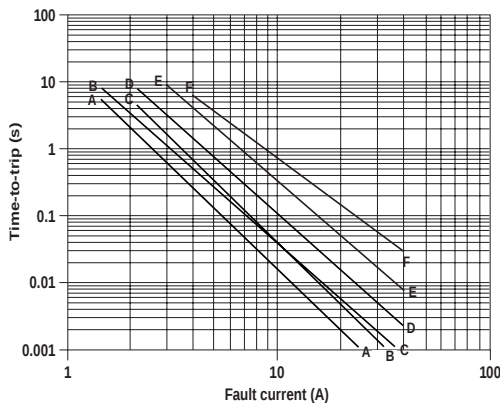
Figure S14



miniSMDM and miniSMDMxxxF (data at 25°C)

- A = miniSMDM075,
miniSMDM075/24,
miniSMDM075F/24
B = miniSMDM110,
miniSMDM110F,
miniSMDM110/16,
miniSMDM110F/116
C = miniSMDM150/24
D = miniSMDM160
E = miniSMDM200,
miniSMDM200F
F = miniSMDM260,
miniSMDM260F

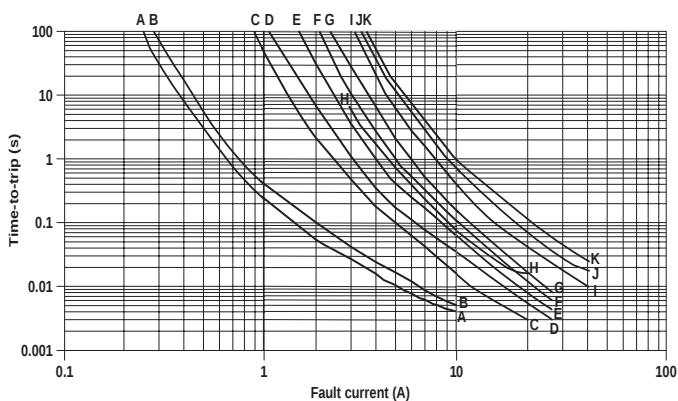
Figure S15



miniSMDC, miniSMDCxxxF and miniSMDE

- A = miniSMDC014, miniSMDC014F
B = miniSMDC020, miniSMDC020F
C = miniSMDC050, miniSMDC050F
D = miniSMDC075, miniSMDC075F
E = miniSMDC110, miniSMDC110F,
miniSMDC110F/16
F = miniSMDC125, miniSMDC125F,
miniSMDC125F/16
G = miniSMDC150, miniSMDC150F
H = miniSMDC160F
I = miniSMDC200, miniSMDC200F
J = miniSMDE190
K = miniSMDC260, miniSMDC260F

Figure S16

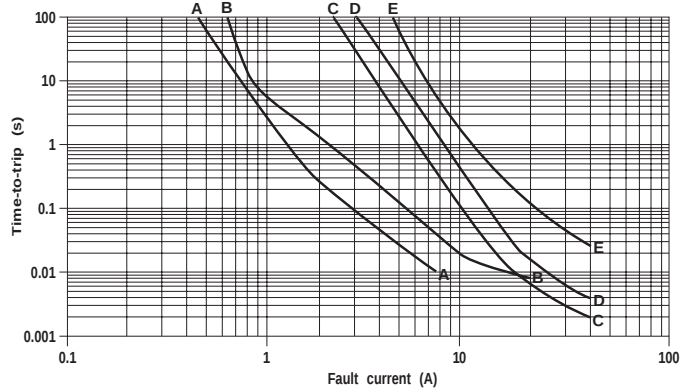


Figures S11–S19. Typical Time-to-Trip Curves at 20°C for Surface-mount Devices

midSMD

- A = SMD030-2018,
SMD030F-2018
- B = SMD050-2018
- C = SMD100-2018,
SMD100F-2018
- D = SMD150-2018,
SMD150F-2018
- E = SMD200-2018,
SMD200F-2018

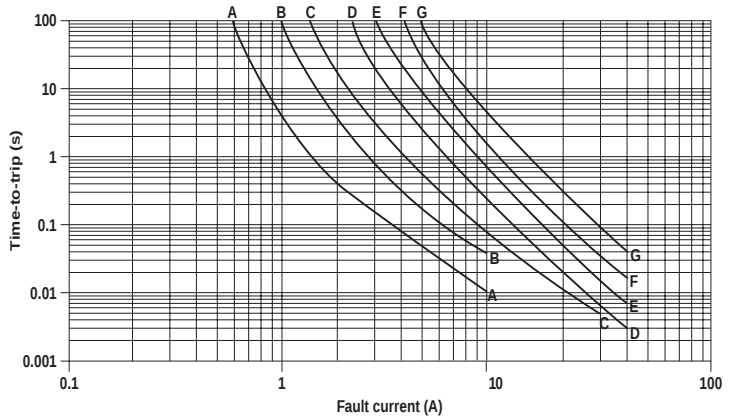
Figure S17



SMD and SMDxxxF

- A = SMD030, SMD030F
- B = SMD050, SMD050F
- C = SMD075, SMD075F,
SMD075F/60
- D = SMD100, SMD100F,
SMD100/33, SMD100F/33
- E = SMD125, SMD125F
- F = SMD260, SMD260RB,
SMD260F
- G = SMD300, SMD300F

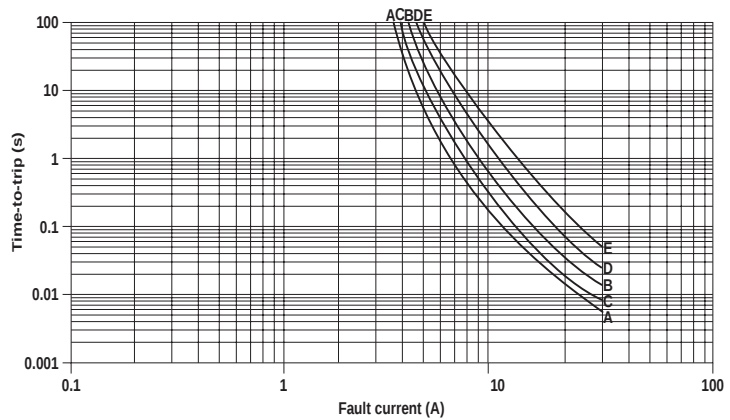
Figure S18



SMD2 and SMDxxxF

- A = SMD150, SMD150F,
SMD150/33, SMD150F/33
- B = SMDH160
- C = SMD185, SMD185F
- D = SMD200, SMD200F
- E = SMD250, SMD250F

Figure S19



**Table S5. Physical Characteristics and Environmental Specifications for Surface-mount Devices
Operating temperature range -40°C to 85°C, -40°C to 125°C for SMDH160****Physical Characteristics**

Terminal pad material	Solder-plated copper for nanoSMDC, microSMD, and miniSMDC series Gold plating for nanoSMDM, and miniSMDM series 100% tin for SMD series
Soldering characteristics	ANSI/J-STD-002B Category 3 for nanoSMDC, nanoSMDM, microSMD, miniSMDC, and miniSMDM series ANSI/J-STD-002B Category 1 for SMD series
Solder heat withstand	per IEC-STD 68-2-20, Test Tb, Section 5, Method 1A
Flammability resistance	per IEC 695-2-2 Needle Flame Test for 20 sec.
Recommended storage conditions	40°C max, 70% R.H. max; devices may not meet specified ratings if storage conditions are exceeded.

Environmental Specifications

Test	Test Method	Conditions	Resistance Change
Passive aging	Raychem PS300, Section 5.3.2	60°C, 1000 hours	±3% typical
		85°C, 1000 hours	±5% typical
Humidity aging	Raychem PS300, Section 5.3.1	85°C, 85% RH, 100 hours	±1.2% typical
Thermal shock	MIL-STD-202, Method 107G	85°C, -40°C (20 times)	-33% typical
		125°C, -55°C (10 times)	-33% typical
Vibration	MIL-STD-883C	per MIL-STD-883C	No change
Solvent resistance	Raychem PS300, Section 5.2.2	Freon	No change
		Trichloroethane	No change
		Hydrocarbons	No change

Agency Recognition for Surface-mount Devices*

UL	File # E74889 for all surface-mount devices
CSA	File # CA78165 for SMD/miniSMDC/miniSMDM/microSMD/nanoSMDC/nanoSMDM series
TÜV	Certificate # R9872048 for microSMD/miniSMDC/miniSMDM series
	Certificate # R2172061 for nanoSMDM/nanoSMDC series
	Certificate # R9872049 for SMD series

*Refer to Telecom and Networking section for agency recognition on Telecom and Networking Surface Mount Devices.



Table S6-A. Packaging and Marking Information for Surface-mount Devices

Part Number	Tape & Reel Quantity	Standard Package	Part Marking	Recommended Pad Layout Figures [mm (In.)]			Agency Recognition
				Dimension A (Nom.)	Dimension B (Nom.)	Dimension C (Nom.)	
nanoSMDC Series							
Size 3216 mm/1206 mils							
nanoSMDC150	3,000	15,000	J	1.60 (0.063)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
Lead-free devices are listed in Table S6-B							
nanoSMDM Series							
Size 3216 mm/1206 mils							
nanoSMDM012	3,000	15,000	012	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM016	3,000	15,000	016	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM050	3,000	15,000	050	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM075	3,000	15,000	075	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM100	3,000	15,000	100	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
Lead-free devices are listed in Table S6-B							
microSMD Series							
Size 3225 mm/1210 mils							
microSMD005	4,000	20,000	05	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD010	4,000	20,000	10	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD035	4,000	20,000	3	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD050	4,000	20,000	50	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD075	4,000	20,000	75	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD110	4,000	20,000	11	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD150	4,000	20,000	15	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
Lead-free devices are listed in Table S6-B							
miniSMDC Series							
Size 4532 mm/1812 mils							
miniSMDC014	2,000	10,000	14	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC020	2,000	10,000	2	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC050	2,000	10,000	5	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC075	2,000	10,000	7	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC110	2,000	10,000	1	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC125	2,000	10,000	12	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC150	2,000	10,000	15	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC200	2,000	10,000	20	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC260	1,500	7,500	26	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
Lead-free devices are listed in Table S6-B							
miniSMDM Series							
Size 4532 mm/1812 mils							
miniSMDM075	3,000	15,000	075	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM075/24	3,000	15,000	075G	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM110	3,000	15,000	110	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM110/16	3,000	15,000	110G	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM150/24	3,000	15,000	150	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM160	3,000	15,000	160	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM200	3,000	15,000	200	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM260	3,000	15,000	260	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
Lead-free devices are listed in Table S6-B							
miniSMDE Series							
Size 11550 mm/4420 mils							
miniSMDE190	5,000	20,000	19	4.75 (0.187)	1.45 (0.057)	9.57 (0.377)	UL, CSA, TÜV



Table S6-A. Packaging and Marking Information for Surface-mount Devices *continued*

				Recommended Pad Layout Figures [mm (In.)]			
Part Number	Tape & Reel Quantity	Standard Package	Part Marking	Dimension A (Nom.)	Dimension B (Nom.)	Dimension C (Nom.)	Agency Recognition
midSMD							
Size 5050 mm/2018 mils							
SMD030-2018	4,000	20,000	A03	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD050-2018	4,000	20,000	A05	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA
SMD100-2018	4,000	20,000	A10	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD150-2018	4,000	20,000	A15	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD200-2018	4,000	20,000	A20	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD							
Size 7555 mm/2920 mils							
SMD030	2,000	10,000	030	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD050	2,000	10,000	050	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD075	2,000	10,000	075	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD100	2,000	10,000	100	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD100/33	2,000	10,000	103	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD125	2,000	10,000	125	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD260	2,000	10,000	260	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD260-RB	2,000	10,000	260	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
SMD300	2,000	10,000	300	3.1 (0.12)	2.3 (0.09)	5.1 (0.201)	UL, CSA, TÜV
Lead-free devices are listed in Table S6-B							
SMD2							
Size 8763 mm/3425 mils							
SMD150	1,500	7,500	150	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMD150/33	1,500	7,500	153	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMDH160	1,500	7,500	160	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	
SMD185	1,500	7,500	185	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMD200	1,500	7,500	200	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMD250	1,500	7,500	250	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
Lead-free devices are listed in Table S6-B							
Telecom Surface-mount							
TSL250-080	1,500	7,500	T08	3.6 (0.14)	1.8 (0.07)	5.5 (0.22)	UL, CSA, TÜV
TS250-130	1,500	7,500	T13	4.6 (0.18)	1.8 (0.07)	6.1 (0.24)	UL, CSA, TÜV
TSV250-130	1,200	6,000	T13V	*	*	*	UL, CSA, TÜV
TS600-170	300	900	T20	9.91 (0.390)	3.30 (0.130)	3.35 (0.132)	UL, CSA
TS600-200-RA	300	900	T20	9.91 (0.390)	3.30 (0.130)	3.35 (0.132)	UL, CSA
TSM600-250	200	1,000	TSM600	*	*	*	UL, CSA

*For TSV250-130 and BM 600-250 pad layout, see Telecom and Networking Section.



Table S6-B. Packaging and Marking Information for **Lead-free** Surface-mount Devices

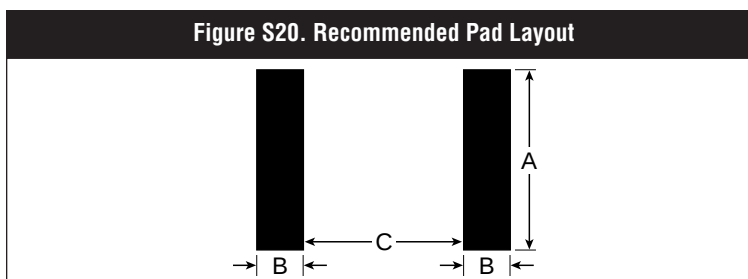
				Recommended Pad Layout Figures [mm (In.)]			
Part Number	Tape & Reel Quantity	Standard Package	Part Marking	Dimension A (Nom.)	Dimension B (Nom.)	Dimension C (Nom.)	Agency Recognition
Lead-free nanoSMDC Series Size 3216 mm/1206 mils							
nanoSMDC020F	3,000	15,000	02	1.60 (0.063)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
nanoSMDC035F	3,000	15,000	03	1.60 (0.063)	1.00 (0.039)	2.00 (0.079)	UL, CSA
nanoSMDC050F/13.2	3,000	15,000	M	1.60 (0.063)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
nanoSMDC075F	3,000	15,000	L	1.60 (0.063)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
nanoSMDC110F	3,000	15,000	K	1.60 (0.063)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
nanoSMDC150F	3,000	15,000	J	1.60 (0.063)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
Lead-free nanoSMDM Series Size 3216 mm/1206 mils							
nanoSMDM012F	3,000	15,000	012F	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM020F	3,000	15,000	02F	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM050F	3,000	15,000	05F	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM050F/13.2	3,000	15,000	5FG	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM075F	3,000	15,000	07F	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
nanoSMDM100F	3,000	15,000	10F	1.80 (0.071)	1.00 (0.039)	1.5 (0.059)	UL, CSA, TÜV
Lead-free microSMD Series Size 3225 mm/1210 mils							
microSMD005F	4,000	20,000	05F	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD010F	4,000	20,000	10	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD035F	4,000	20,000	3	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD050F	4,000	20,000	50	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD075F	4,000	20,000	75	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD110F	4,000	20,000	11	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
microSMD150F	4,000	20,000	15	2.50 (0.098)	1.00 (0.039)	2.00 (0.079)	UL, CSA, TÜV
Lead-free miniSMDC Series Size 4532 mm/1812 mils							
miniSMDC014F	2,000	10,000	14	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC020F	2,000	10,000	2	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC050F	2,000	10,000	5	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC075F	2,000	10,000	7	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC110F	2,000	10,000	1	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC110F/16	2,000	10,000	110F 16V	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC125F	2,000	10,000	12	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC125F/16	2,000	10,000	125F 16V	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC150F	2,000	10,000	15	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC160F	2,000	10,000	16	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC200F	2,000	10,000	20	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC260F	1,500	7,500	26	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV
miniSMDC260F/12	1,500	7,500	260F 12V	3.15 (0.124)	1.78 (0.070)	3.45 (0.136)	UL, CSA, TÜV



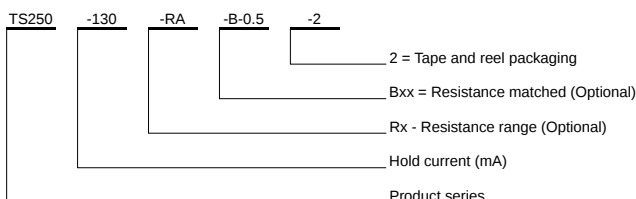
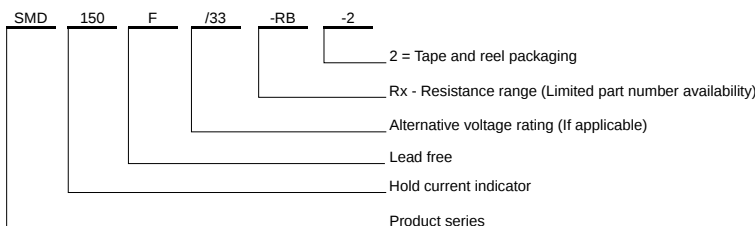
Table S6-B. Packaging and Marking Information for **Lead-free** Surface-mount Devices *continued*

				Recommended Pad Layout Figures [mm (In.)]			
Part Number	Tape & Reel Quantity	Standard Package	Part Marking	Dimension A (Nom.)	Dimension B (Nom.)	Dimension C (Nom.)	Agency Recognition
Lead-free miniSMD Series Size 4532 mm/1812 mils							
miniSMDM075F/24	3,000	15,000	07FG	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM110F	3,000	15,000	110F	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM110F/16	3,000	15,000	11FG	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM200F	3,000	15,000	200F	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
miniSMDM260F	3,000	15,000	260F	3.20 (0.126)	1.50 (0.059)	2.50 (0.098)	UL, CSA, TÜV
Lead-free midSMD Series Size 5050 mm/2018 mils							
SMD030F-2018	4,000	20,000	A03F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD100F-2018	4,000	20,000	A10F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD150F-2018	4,000	20,000	A15F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD200F-2018	4,000	20,000	A20F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
Lead-free SMD Series Size 7555 mm/2920 mils							
SMD030F	2,000	10,000	030F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD050F	2,000	10,000	050F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD075F	2,000	10,000	075F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD075F/60	2,000	10,000	075F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA
SMD100F	2,000	10,000	100F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD100F/33	2,000	10,000	103F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD125F	2,000	10,000	125F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD260F	2,000	10,000	260F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
SMD300F	2,000	10,000	300F	4.6 (0.18)	1.50 (0.059)	3.4 (0.134)	UL, CSA, TÜV
Lead-free SMD2 Devices Size 8763 mm/3425 mils							
SMD150F	1,500	7,500	150F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMD150F/33	1,500	7,500	153F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMD185F	1,500	7,500	185F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMD200F	1,500	7,500	200F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV
SMD250F	1,500	7,500	250F	4.6 (0.18)	2.3 (0.09)	6.1 (0.240)	UL, CSA, TÜV

Figure S20. Recommended Pad Layout



Part Numbering System

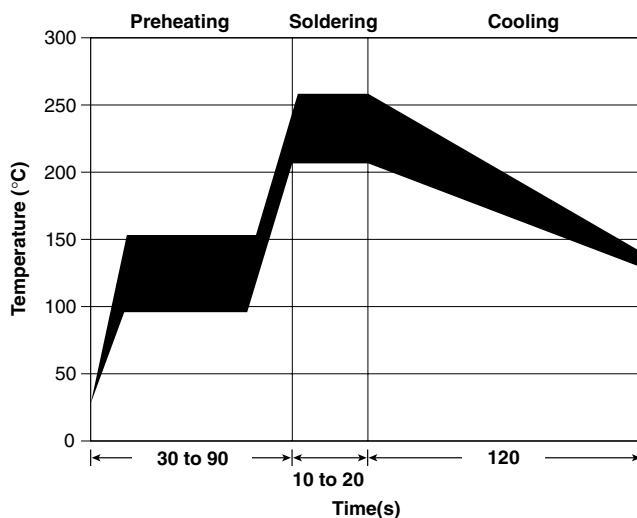


Solder Reflow and Rework Recommendations for Surface-mount Devices

Solder Reflow

- Recommended reflow methods: IR, Vapor phase, and hot air oven.
- The following product series are not designed to be wave soldered to circuit boards:
 - nanoSMDM
 - miniSMDM
 - midSMD
 - SMD
 - SMD2
 - TS
- The following product series are designed to be wave soldered to circuit boards:
 - nanoSMDC
 - microSMD
 - miniSMDC, miniSMDE
- Recommended maximum paste thickness for the microSMD, miniSMDC, and miniSMDE devices is 0.25 mm (10mils), 0.13-0.25 mm for miniSMDM and nanoSMDM, and 0.38 mm for SMD.
- Devices can be cleaned using standard methods and solvents.

Figure S21



Caution:

- If reflow temperatures exceed the recommended profile, devices may not meet the performance specifications.

Rework

- Use standard industry practices for the nanoSMDC, nanoSMDM, microSMD, miniSMDC, miniSMDM, and miniSMDE devices.
- For SMD and midSMD series and all TS devices rework should be confined to removal of the installed product and replacement with a fresh device.



Table S7. Tape and Reel Specifications for Surface-mount Devices (in Millimeters)

	nanoSMDC nanoSMDM	microSMD	miniSMDC miniSMDM	miniSMDE190	midSMD	SMD	SMD2
	EIA 481-1	EIA 481-1	EIA 481-1	EIA 481-2	EIA 481-2	EIA 481-2	EIA 481-2
W	8.0 ± 0.30	8.0 ± 0.30	12.0 ± 0.30	24.0 ± 0.30	16.0 ± 0.30	16.0 ± 0.30	16.0 ± 0.30
P ₀	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10	4.0 ± 0.10
P ₁	4.0 ± 0.10	4.0 ± 0.10	8.0 ± 0.10	8.0 ± 0.10	8.0 ± 0.10	8.0 ± 0.10	12.0 ± 0.10
P ₂	2.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.05	2.0 ± 0.10	2.0 ± 0.10	2.0 ± 0.10	2.0 ± 0.10
A ₀	Table S7a	2.9 ± 0.10	Table S7b	5.70 ± 0.10	5.11 ± 0.15	5.6 ± 0.23	6.9 ± 0.23
B ₀	Table S7a	3.5 ± 0.10	Table S7b	11.90 ± 0.10	5.6 ± 0.23	8.1 ± 0.15	9.6 ± 0.15
B ₁ max.	4.35	4.35	8.2**	20.1	12.1	12.1	12.1
D ₀	1.5 + 0.10/ -0.00	1.5 + 0.10/ -0.00	1.5 + 0.10/ -0.00	1.5 + 0.10/ -0.00	1.5 + 0.10/ -0.00	1.5 + 0.10/ -0.00	1.5 + 0.10/ -0.00
F	3.5 ± 0.05	3.5 ± 0.05	5.5 ± 0.05	11.5 ± 0.10	7.5 ± 0.10	7.5 ± 0.10	7.5 ± 0.10
E ₁	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10	1.75 ± 0.10
E ₂ min.	6.25	6.25	10.25	22.25	14.25	14.25	14.25
T max.	0.6	0.6	0.6	0.6	0.6	0.6	0.6
T ₁ max.	0.1	0.1	0.1	0.1	0.1	0.1	0.1
K ₀	Table S7a	0.90 ± 0.10*	Table S7b	0.95 ± 0.10	1.8 ± 0.15	3.2 ± 0.15	3.4 ± 0.15
Leader min.	390***	390	390***	400	400	400	400
Trailer min.	160***	160	160***	160	160	160	160

*1.1±0.05 for microSMD150

**5.9 for miniSMDM

***200 for nanoSMDM, miniSMDM

Table S7a

	nanoSMDC150	nanoSMDM
A ₀	2.3 ± 0.10	1.88 ± 0.10
B ₀	3.5 ± 0.10	3.5 ± 0.10
K ₀	1.45 ± 0.10	1.4 ± 0.10

Table S7b

	miniSMDC	miniSMDC260	miniSMDM
A ₀	3.5 ± 0.23	3.7 ± 0.10	3.5 ± 0.23
B ₀	5.1 ± 0.15	4.9 ± 0.10	5.1 ± 0.15
K ₀	0.9 ± 0.15	1.4 ± 0.10	2.3 ± 0.15

Table S7c. Reel Dimensions for Surface-mount Devices (in millimeters)

	nanoSMDC nanoSMDM	microSMD	miniSMDC	miniSMDM	miniSMDE190	midSMD	SMD	SMD2
A max.	180	180	180	340	330	330	330	330
N min.	50	50	50	50	60	50	50	50
W ₁	8.5 + 1.5/-0.00	8.4 + 1.5/-0.00	12.4 + 2.0/-0.00	12.4 + 2.0/-0.00	24.4 + 2.0/-0.00	16.4 + 2.0/-0.00	16.4 + 2.0/-0.00	16.4 + 2.0/-0.00
W ₂ max.	14.4	14.4	18.4	18.4	30.4	22.4	22.4	22.4



Figure S21. EIA Taped Component Dimensions

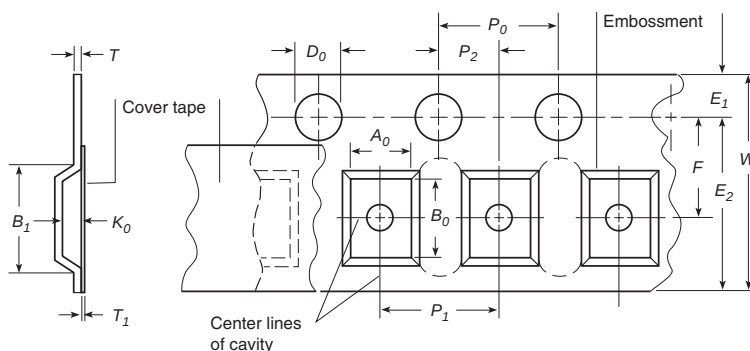
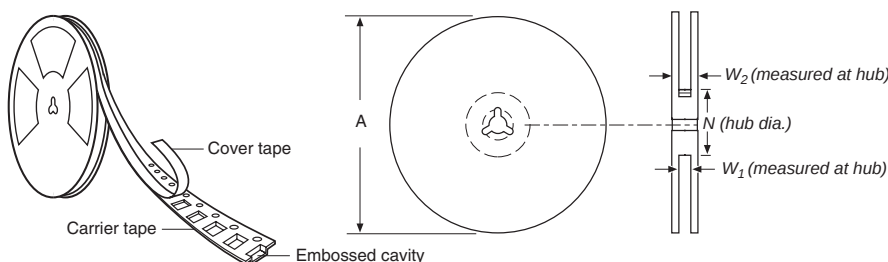


Figure S22. EIA Reel Dimensions



Latest Information

- Please visit us at www.circuitprotection.com or contact your local representative for the latest information.
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WARNING:

- Operation beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.
- The devices are intended for protection against occasional overcurrent or overtemperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated.
- Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices.
- Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.
- Operation in circuits with a large inductance can generate a circuit voltage ($L \frac{di}{dt}$) above the rated voltage of the PolySwitch resettable device.

